

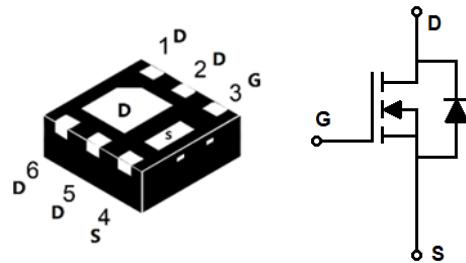
Features

- N-Channel, Low $R_{DS(on)}$ @ $V_{GS}=10V$
- 5V Logic Level Control
- 100% UIS Tested
- Green Device Available

$V_{(BR)DSS}$	$R_{DS(ON)} \text{ Typ}$	$I_D \text{ Max}$
100V	28mΩ @ 10V	8A
	34.5mΩ @ 4.5V	

Applications

- Quick Charger
- Load Switch
- LED backlighting
- Telecom
- Industrial power supplies


Order Information
DFN2X2-6L

Product	Package	Marking	Packing
FTK2392LDFN22	DFN2X2-6L	2392	3000PCS/Reel

Absolute Maximum Ratings

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Symbol	Parameter	Rating	Unit
Common Ratings ($T_j=25^\circ\text{C}$ Unless Otherwise Noted)			
V_{GS}	Gate-Source Voltage	± 20	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	100	V
T_J, T_{STG}	Junction and Storage Temperature Range	-50 to 150	°C

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested①	$T_c = 25^\circ\text{C}$	45	A
I_s	Diode continuous forward current	$T_c = 25^\circ\text{C}$	8	A
I_D	Continuous Drain Current	$T_c = 25^\circ\text{C}$	8	A
		$T_c = 70^\circ\text{C}$	6.4	
P_D	Maximum Power Dissipation	$T_c = 25^\circ\text{C}$	2.7	W
$R_{θJA}$	Thermal Resistance-Junction Ambient		80	°C/W



FTK2392LDFN22

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	100	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current($T_c=25^\circ\text{C}$)	$V_{\text{DS}}=100\text{V}$, $V_{\text{GS}}=0\text{V}$	--	--	1	μA
	Zero Gate Voltage Drain Current($T_c=125^\circ\text{C}$)	$V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=0\text{V}$	--	--	100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	--	--	± 100	nA
$V_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_D=250\mu\text{A}$	1.0	1.8	2.5	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance ^③	$V_{\text{GS}}=10\text{V}$, $I_D=8\text{A}$	--	28	35	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance ^③	$V_{\text{GS}}=4.5\text{V}$, $I_D=4\text{A}$	--	34.5	44	$\text{m}\Omega$
Dynamic Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
C_{iss}	Input Capacitance	$V_{\text{DS}}=50\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	--	477	--	pF
C_{oss}	Output Capacitance		--	155	--	pF
C_{rss}	Reverse Transfer Capacitance		--	17	--	pF
R_g	Gate Resistance	$f=1\text{MHz}$		2.5		Ω
Q_g	Total Gate Charge	$V_{\text{DS}}=50\text{V}$, $I_D=5\text{A}$, $V_{\text{GS}}=10\text{V}$	--	8.7	--	nC
Q_{gs}	Gate Source Charge		--	1.7	--	nC
Q_{gd}	Gate Drain Charge		--	2.9	--	nC
Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
$t_{\text{d}(\text{on})}$	Turn on Delay Time	$V_{\text{DD}}=50\text{V}$, $I_D=1\text{A}$, $R_g=6\Omega$, $V_{\text{GS}}=10\text{V}$	--	7.6	--	ns
t_r	Turn on Rise Time		--	3.8	--	ns
$t_{\text{d}(\text{off})}$	Turn Off Delay Time		-	23.2	--	ns
t_f	Turn Off Fall Time		--	5.4	--	ns
Source Drain Diode Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
V_{SD}	Forward on voltage ^③	$I_{\text{SD}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$	--	--	1.2	V

Notes: ① Pulse width limited by maximum allowable junction temperature

② Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.

Typical Characteristics

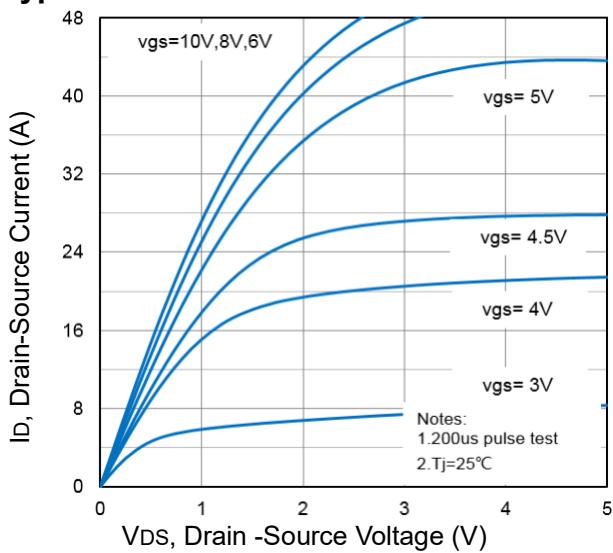


Fig1. Typical Output Characteristics

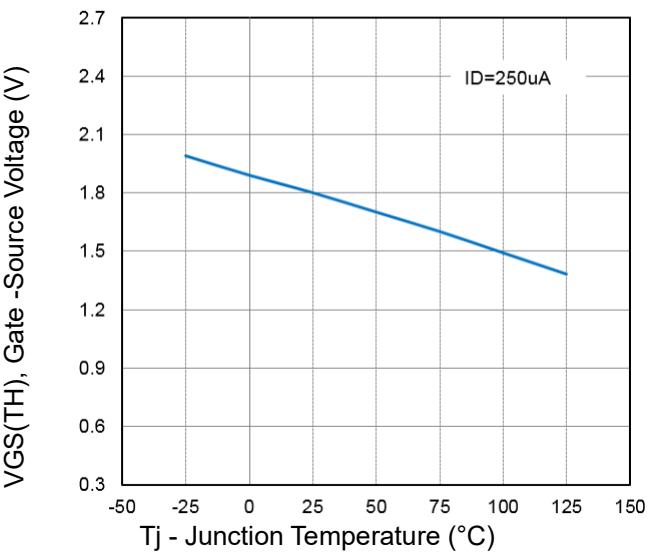


Fig2. $V_{GS(TH)}$ Voltage Vs. Temperature

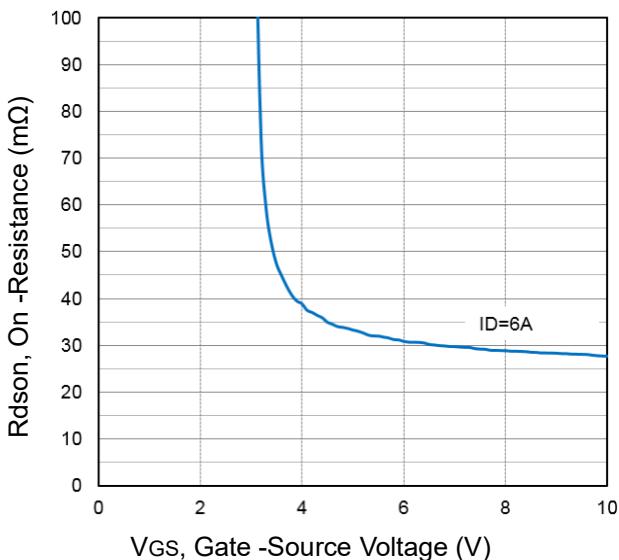


Fig3. On-Resistance vs Gate Source Voltage

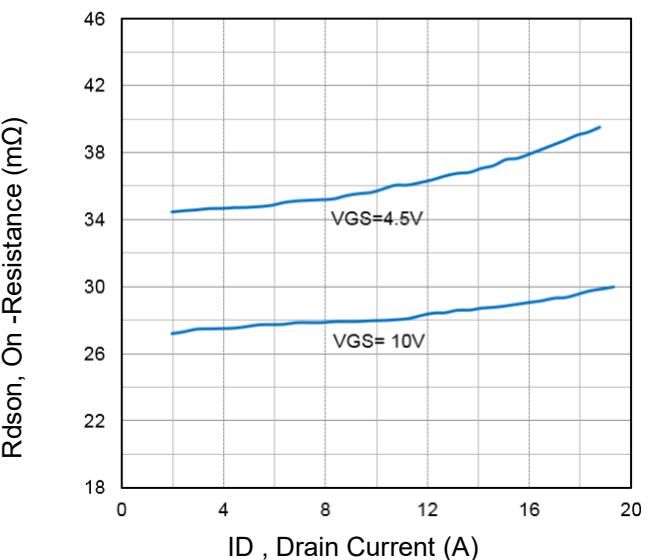


Fig4. On-Resistance vs. Drain Current and Gate Voltage

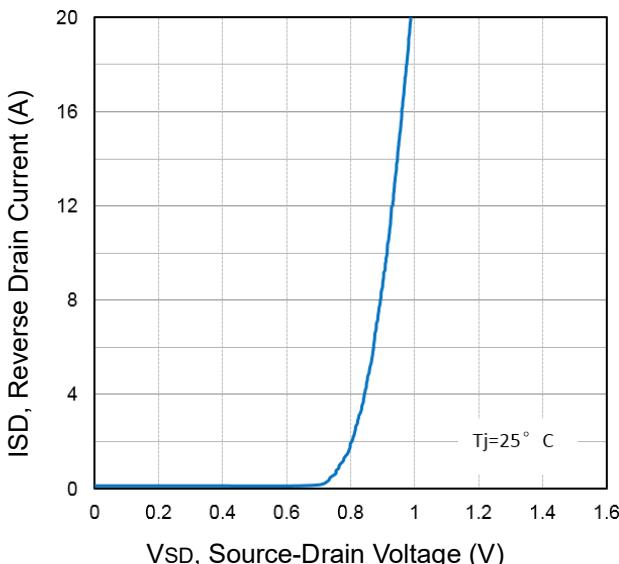


Fig5. Typical Source-Drain Diode Forward Voltage

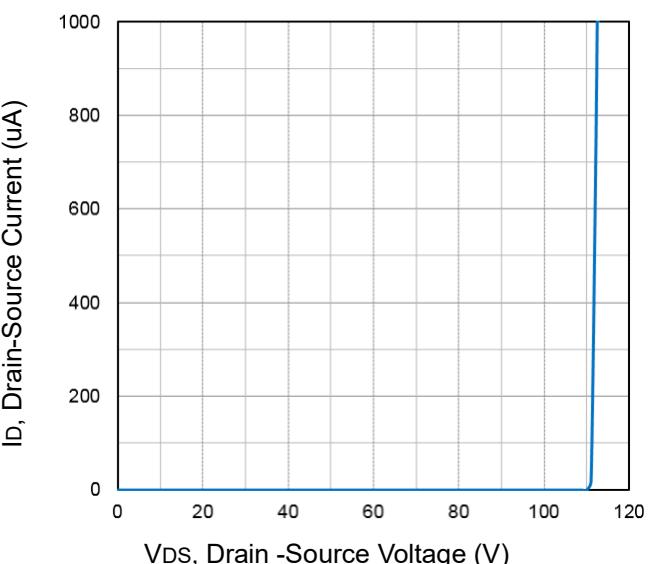


Fig6. On-Resistance vs Gate Source Voltage

Typical Characteristics

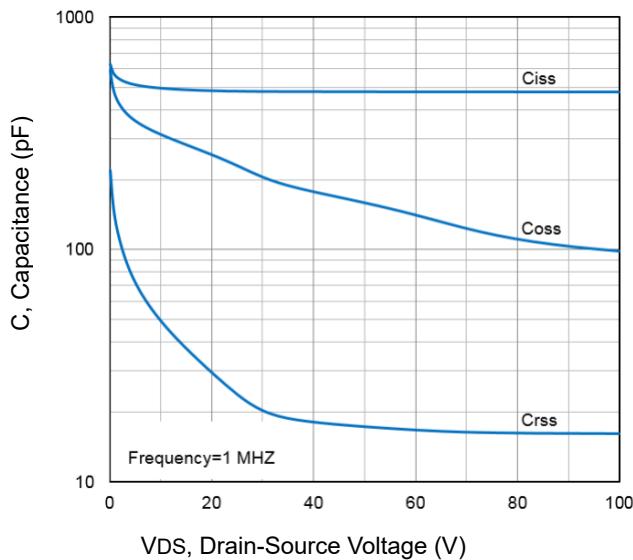


Fig7. Typical Capacitance Vs. Drain-Source Voltage

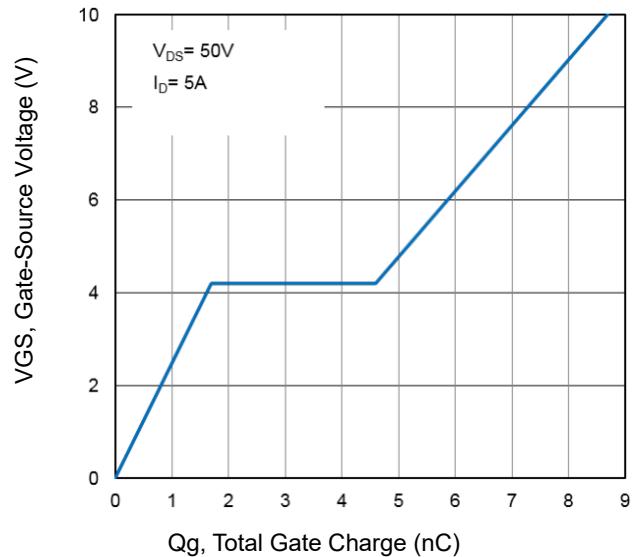


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

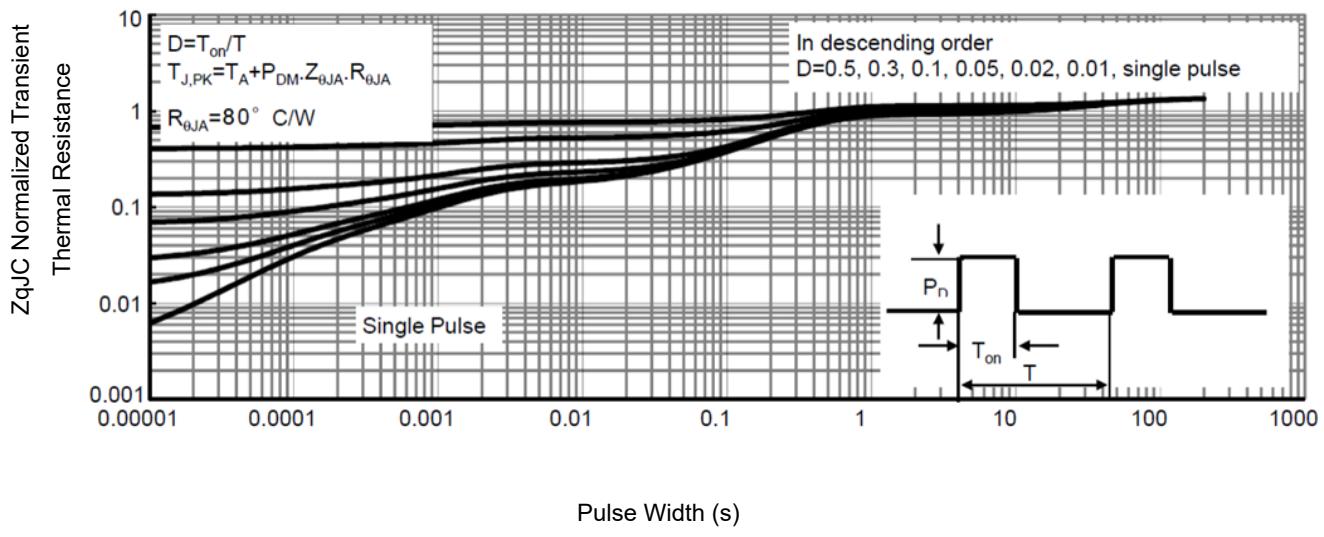


Fig9. Normalized Maximum Transient Thermal Impedance

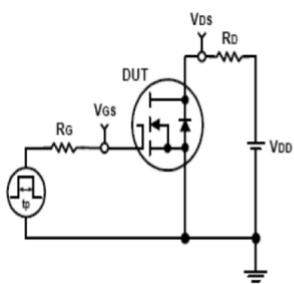


Fig10. Switching Time Test Circuit and waveforms

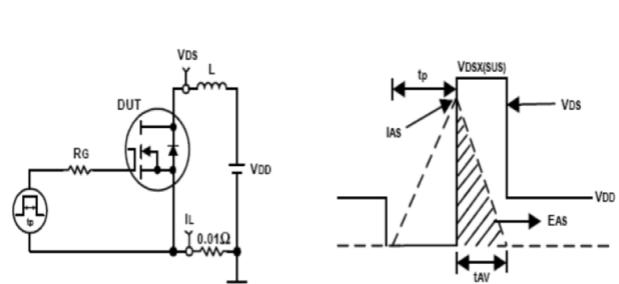
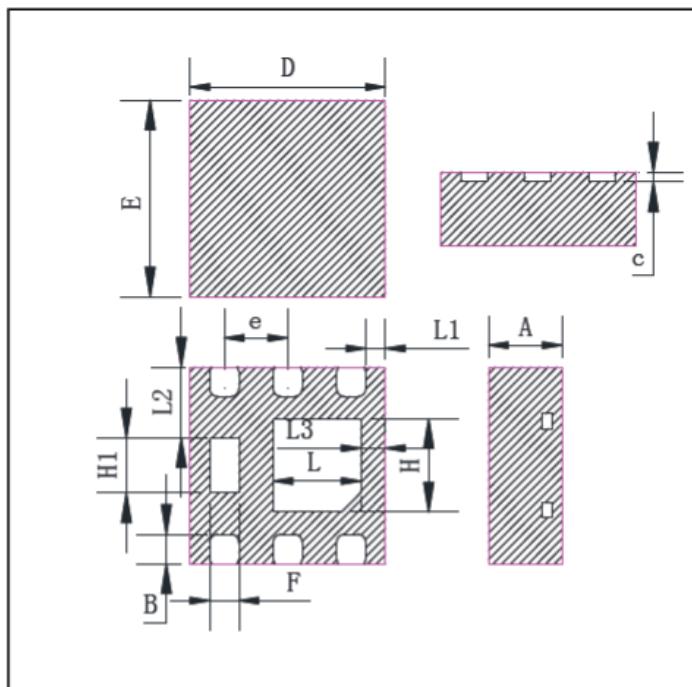


Fig11. Unclamped Inductive Test Circuit and waveforms

DFN2X2-6L Mechanical Data



Symbol	Min	Typ	Max
A	0.65	0.70	0.75
B	0.25	0.30	0.35
C	0.153	0.203	0.253
D	1.90	2.00	2.10
E	1.90	2.00	2.10
e	0.60	0.65	0.70
F	0.25	0.30	0.35
H	0.85	0.95	1.05
H1	0.51	0.56	0.61
L	0.80	0.90	1.00
L1	0.15	0.20	0.25
L2	0.62	0.72	0.82
L3	0.25	0.30	0.35